

To our customers,

Old Company Name in Catalogs and Other Documents

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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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HZM-N Series

Silicon Epitaxial Planar Zener Diode for Stabilizer

REJ03G0483-0500
(Previous: ADE-208-130D)
Rev.5.00
Dec 14, 2004

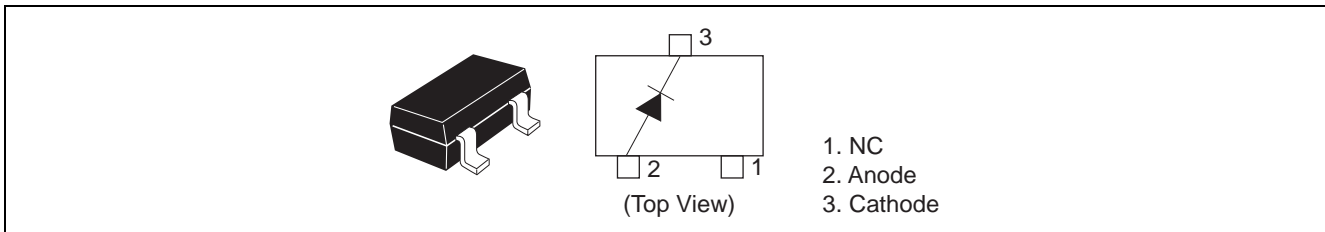
Features

- Wide spectrum from 1.9 V through 38 V of zener voltage provide flexible application.
- MPAK Package is suitable for high density surface mounting and high speed assembly.

Ordering Information

| Type No. | Laser Mark | Package Code |
|--------------|------------------|--------------|
| HZM-N Series | Let to Mark Code | MPAK |

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

| Item | Symbol | Value | Unit |
|----------------------|--------|-------------|------|
| Power dissipation | Pd *1 | 200 | mW |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Note: 1. See Fig. 3.

Electrical Characteristics

(Ta = 25°C)

| Type | Grade | Zener Voltage | | Reverse Current | | Dynamic Resistance | | |
|---------|-------|---------------|------|---------------------|---------------------|--------------------|--------------------|---------------------|
| | | Vz (V)*1 | | Test Condition | I _R (μA) | Test Condition | r _d (Ω) | Test Condition |
| | | Min | Max | I _Z (mA) | Max | V _R (V) | Max | I _Z (mA) |
| HZM2.0N | B | 1.90 | 2.20 | 5 | 120 | 0.5 | 100 | 5 |
| HZM2.2N | B | 2.10 | 2.40 | 5 | 120 | 0.7 | 100 | 5 |
| HZM2.4N | B | 2.30 | 2.60 | 5 | 120 | 1.0 | 100 | 5 |
| HZM2.7N | B | 2.50 | 2.90 | 5 | 120 | 1.0 | 110 | 5 |
| | B1 | 2.50 | 2.75 | | | | | |
| | B2 | 2.65 | 2.90 | | | | | |
| HZM3.0N | B | 2.80 | 3.20 | 5 | 50 | 1.0 | 120 | 5 |
| | B1 | 2.80 | 3.05 | | | | | |
| | B2 | 2.95 | 3.20 | | | | | |
| HZM3.3N | B | 3.10 | 3.50 | 5 | 20 | 1.0 | 130 | 5 |
| | B1 | 3.10 | 3.35 | | | | | |
| | B2 | 3.25 | 3.50 | | | | | |
| HZM3.6N | B | 3.40 | 3.80 | 5 | 10 | 1.0 | 130 | 5 |
| | B1 | 3.40 | 3.65 | | | | | |
| | B2 | 3.55 | 3.80 | | | | | |
| HZM3.9N | B | 3.70 | 4.10 | 5 | 10 | 1.0 | 130 | 5 |
| | B1 | 3.70 | 3.97 | | | | | |
| | B2 | 3.87 | 4.10 | | | | | |
| HZM4.3N | B | 4.01 | 4.48 | 5 | 10 | 1.0 | 130 | 5 |
| | B1 | 4.01 | 4.21 | | | | | |
| | B2 | 4.15 | 4.34 | | | | | |
| | B3 | 4.28 | 4.48 | | | | | |
| HZM4.7N | B | 4.42 | 4.90 | 5 | 10 | 1.0 | 130 | 5 |
| | B1 | 4.42 | 4.61 | | | | | |
| | B2 | 4.55 | 4.75 | | | | | |
| | B3 | 4.69 | 4.90 | | | | | |
| HZM5.1N | B | 4.84 | 5.37 | 5 | 5 | 1.5 | 130 | 5 |
| | B1 | 4.84 | 5.04 | | | | | |
| | B2 | 4.98 | 5.20 | | | | | |
| | B3 | 5.14 | 5.37 | | | | | |
| HZM5.6N | B | 5.31 | 5.92 | 5 | 5 | 2.5 | 80 | 5 |
| | B1 | 5.31 | 5.55 | | | | | |
| | B2 | 5.49 | 5.73 | | | | | |
| | B3 | 5.67 | 5.92 | | | | | |

Note: 1. Tested with pulse (P_w = 40 ms)

| Type | Grade | Zener Voltage | | Reverse Current | | | Dynamic Resistance | |
|---------|-------|-------------------------|-------|-----------------|------------------|----------------|--------------------|----------------|
| | | V_Z (V)* ¹ | | Test Condition | I_R (μ A) | Test Condition | r_d (Ω) | Test Condition |
| | | Min | Max | I_Z (mA) | Max | V_R (V) | Max | I_Z (mA) |
| HZM6.2N | B | 5.86 | 6.53 | 5 | 2 | 3.0 | 50 | 5 |
| | B1 | 5.86 | 6.12 | | | | | |
| | B2 | 6.06 | 6.33 | | | | | |
| | B3 | 6.26 | 6.53 | | | | | |
| HZM6.8N | B | 6.47 | 7.14 | 5 | 2 | 3.5 | 30 | 5 |
| | B1 | 6.47 | 6.73 | | | | | |
| | B2 | 6.65 | 6.93 | | | | | |
| | B3 | 6.86 | 7.14 | | | | | |
| HZM7.5N | B | 7.06 | 7.84 | 5 | 2 | 4.0 | 30 | 5 |
| | B1 | 7.06 | 7.36 | | | | | |
| | B2 | 7.28 | 7.60 | | | | | |
| | B3 | 7.52 | 7.84 | | | | | |
| HZM8.2N | B | 7.76 | 8.64 | 5 | 2 | 5.0 | 30 | 5 |
| | B1 | 7.76 | 8.10 | | | | | |
| | B2 | 8.02 | 8.36 | | | | | |
| | B3 | 8.28 | 8.64 | | | | | |
| HZM9.1N | B | 8.56 | 9.55 | 5 | 2 | 6.0 | 30 | 5 |
| | B1 | 8.56 | 8.93 | | | | | |
| | B2 | 8.85 | 9.23 | | | | | |
| | B3 | 9.15 | 9.55 | | | | | |
| HZM10N | B | 9.45 | 10.55 | 5 | 2 | 7.0 | 30 | 5 |
| | B1 | 9.45 | 9.87 | | | | | |
| | B2 | 9.77 | 10.21 | | | | | |
| | B3 | 10.11 | 10.55 | | | | | |
| HZM11N | B | 10.44 | 11.56 | 5 | 2 | 8.0 | 30 | 5 |
| | B1 | 10.44 | 10.88 | | | | | |
| | B2 | 10.76 | 11.22 | | | | | |
| | B3 | 11.10 | 11.56 | | | | | |
| HZM12N | B | 11.42 | 12.60 | 5 | 2 | 9.0 | 35 | 5 |
| | B1 | 11.42 | 11.90 | | | | | |
| | B2 | 11.74 | 12.24 | | | | | |
| | B3 | 12.08 | 12.60 | | | | | |
| HZM13N | B | 12.47 | 13.96 | 5 | 2 | 10.0 | 35 | 5 |
| | B1 | 12.47 | 13.03 | | | | | |
| | B2 | 12.91 | 13.49 | | | | | |
| | B3 | 13.37 | 13.96 | | | | | |
| 5M15N | B | 13.84 | 15.52 | 5 | 2 | 11.0 | 40 | 5 |
| | B1 | 13.84 | 14.46 | | | | | |
| | B2 | 14.34 | 14.98 | | | | | |
| | B3 | 14.85 | 15.52 | | | | | |
| HZM16N | B | 15.37 | 17.09 | 5 | 2 | 12.0 | 40 | 5 |
| | B1 | 15.37 | 16.01 | | | | | |
| | B2 | 15.85 | 16.51 | | | | | |
| | B3 | 16.35 | 17.09 | | | | | |
| HZM18N | B | 16.94 | 19.03 | 5 | 2 | 13.0 | 45 | 5 |
| | B1 | 16.94 | 17.70 | | | | | |
| | B2 | 17.56 | 18.35 | | | | | |
| | B3 | 18.21 | 19.03 | | | | | |

Note: 1. Tested with pulse ($P_w = 40$ ms)

| Type | Grade | Zener Voltage | | Reverse Current | | Dynamic Resistance | | |
|--------|-------|-------------------------|-------|-----------------|------------------|--------------------|--------------------|----------------|
| | | V_Z (V)* ¹ | | Test Condition | I_R (μ A) | Test Condition | r_d (Ω) | Test Condition |
| | | Min | Max | I_Z (mA) | Max | V_R (V) | Max | I_Z (mA) |
| HZM20N | B | 18.86 | 21.08 | 5 | 2 | 15.0 | 50 | 5 |
| | B1 | 18.86 | 19.70 | | | | | |
| | B2 | 19.52 | 20.39 | | | | | |
| | B3 | 20.21 | 21.08 | | | | | |
| HZM22N | B | 20.88 | 23.17 | 5 | 2 | 17.0 | 55 | 5 |
| | B1 | 20.88 | 21.77 | | | | | |
| | B2 | 21.54 | 22.47 | | | | | |
| | B3 | 22.23 | 23.17 | | | | | |
| HZM24N | B | 22.93 | 25.57 | 5 | 2 | 19.0 | 60 | 5 |
| | B1 | 22.93 | 23.96 | | | | | |
| | B2 | 23.72 | 24.78 | | | | | |
| | B3 | 24.54 | 25.57 | | | | | |
| HZM27N | B | 25.10 | 28.90 | 2 | 2 | 21.0 | 70 | 2 |
| HZM30N | B | 28.00 | 32.00 | 2 | 2 | 23.0 | 80 | 2 |
| HZM33N | B | 31.00 | 35.00 | 2 | 2 | 25.0 | 80 | 2 |
| HZM36N | B | 34.00 | 38.00 | 2 | 2 | 27.0 | 90 | 2 |

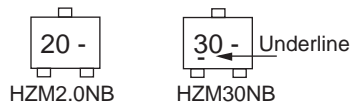
Note: 1. Tested with pulse ($P_w = 40$ ms)

Mark Code

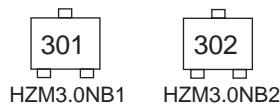
| Type | Grade | Mark No. | Type | Grade | Mark No. | Type | Grade | Mark No. |
|---------|-------|----------|---------|-------|--------------|--------|--------------|--------------|
| HZM2.0N | B | 2 0 - | HZM6.2N | B1 | 6 2 1 | HZM13N | B1 | <u>1</u> 3 1 |
| HZM2.2N | B | 2 2 - | | B2 | 6 2 2 | | B2 | <u>1</u> 3 2 |
| HZM2.4N | B | 2 4 - | | B3 | 6 2 3 | | B3 | <u>1</u> 3 3 |
| HZM2.7N | B1 | 2 7 1 | HZM6.8N | B1 | 6 8 1 | HZM15N | B1 | <u>1</u> 5 1 |
| | B2 | 2 7 2 | | B2 | 6 8 2 | | B2 | <u>1</u> 5 2 |
| HZM3.0N | B1 | 3 0 1 | | B3 | 6 8 3 | | B3 | <u>1</u> 5 3 |
| | B2 | 3 0 2 | HZM7.5N | B1 | 7 5 1 | HZM16N | B1 | <u>1</u> 6 1 |
| HZM3.3N | B1 | 3 3 1 | | B2 | 7 5 2 | | B2 | <u>1</u> 6 2 |
| | B2 | 3 3 2 | | B3 | 7 5 3 | | B3 | <u>1</u> 6 3 |
| HZM3.6N | B1 | 3 6 1 | HZM8.2N | B1 | 8 2 1 | HZM18N | B1 | <u>1</u> 8 1 |
| | B2 | 3 6 2 | | B2 | 8 2 2 | | B2 | <u>1</u> 8 2 |
| HZM3.9N | B1 | 3 9 1 | | B3 | 8 2 3 | | B3 | <u>1</u> 8 3 |
| | B2 | 3 9 2 | HZM9.1N | B1 | 9 1 1 | HZM20N | B1 | <u>2</u> 0 1 |
| HZM4.3N | B1 | 4 3 1 | | B2 | 9 1 2 | | B2 | 2 0 2 |
| | B2 | 4 3 2 | | B3 | 9 1 3 | | B3 | <u>2</u> 0 3 |
| | B3 | 4 3 3 | HZM10N | B1 | <u>1</u> 0 1 | HZM22N | B1 | <u>2</u> 2 1 |
| HZM4.7N | B1 | 4 7 1 | | B2 | <u>1</u> 0 2 | | B2 | <u>2</u> 2 2 |
| | B2 | 4 7 2 | | B3 | <u>1</u> 0 3 | | B3 | <u>2</u> 2 3 |
| | B3 | 4 7 3 | HZM11N | B1 | <u>1</u> 1 1 | HZM24N | B1 | <u>2</u> 4 1 |
| HZM5.1N | B1 | 5 1 1 | | B2 | <u>1</u> 1 2 | | B2 | <u>2</u> 4 2 |
| | B2 | 5 1 2 | | B3 | <u>1</u> 1 3 | | B3 | <u>2</u> 4 3 |
| | B3 | 5 1 3 | HZM12N | B1 | <u>1</u> 2 1 | HZM27N | B | <u>2</u> 7 - |
| HZM5.6N | B1 | 5 6 1 | | B2 | <u>1</u> 2 2 | HZM30N | B | <u>3</u> 0 - |
| | B2 | 5 6 2 | | B3 | <u>1</u> 2 3 | HZM33N | B | <u>3</u> 3 - |
| | B3 | 5 6 3 | | | HZM36N | B | <u>3</u> 6 - | |

Example of Marking

1. One grade type (grade type B)



2. Two grade type (B1, B2)



3. Three grade type (B1, B2, B3)



- Notes:
- The grade B type includes from B1 min. to B3 (or B2) max.
 - B grade is standard and has better delivery, These are marked one of B1, B2, B3.
 - Ordering P/N HZM-N series are delivered taped (TL/TR).
Choose one taping code and adhere to parts No.
Example: HZM2.0NBTL (or TR), HZM2.2NBTL (or TR), HZM36NBTL (or TR).
(Grade B type)
HZM2.7NB1TL (or TR), HZM2.7NB2TL (or TR), HZM24NB3TL (or TR).
(Grade B1, B2, B3 type)

Main Characteristic

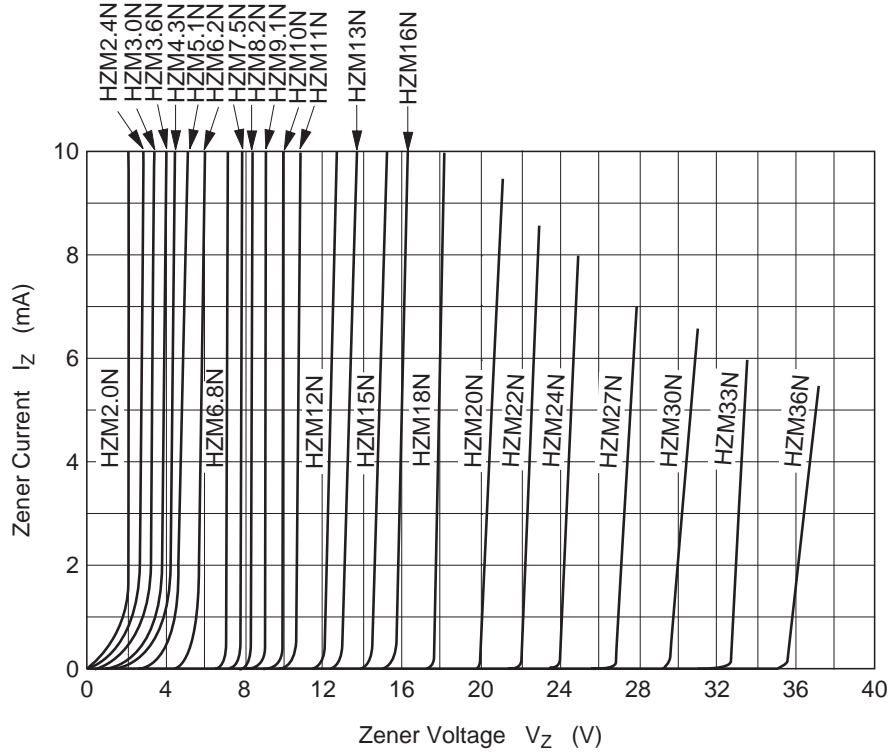


Fig.1 Zener current vs. Zener voltage

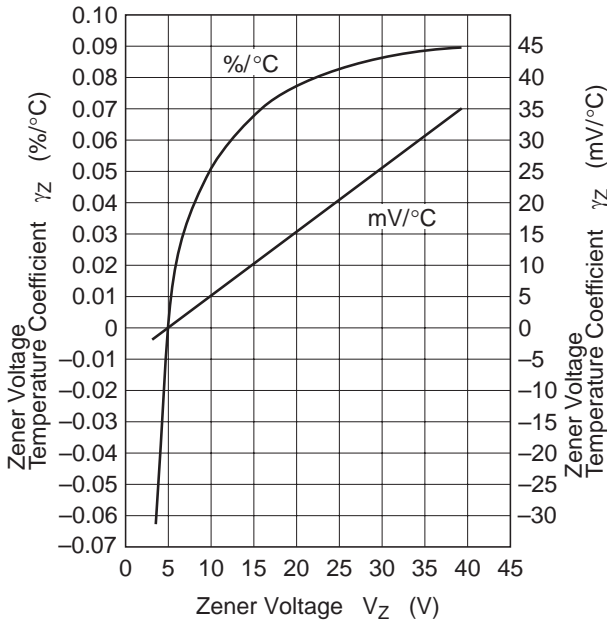


Fig.2 Temperature Coefficient vs. Zener voltage

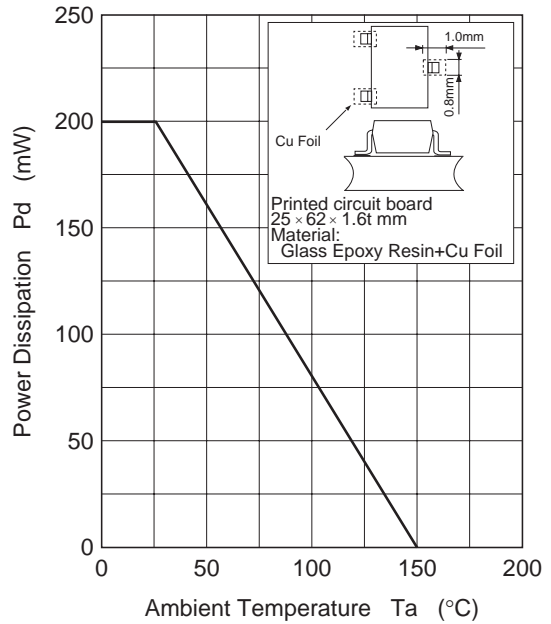
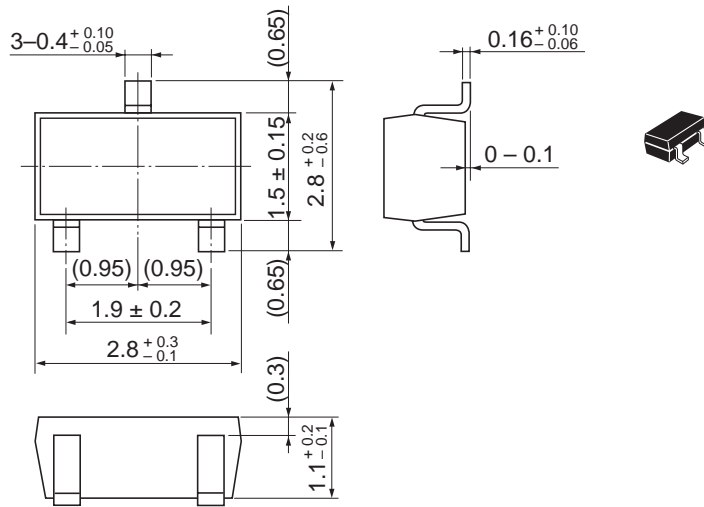


Fig.3 Power Dissipation vs. Ambient Temperature

Package Dimensions

As of January, 2003
Unit: mm



| | |
|------------------------|----------|
| Package Code | MPAK |
| JEDEC | — |
| JEITA | Conforms |
| Mass (reference value) | 0.011 g |

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